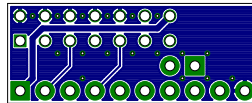


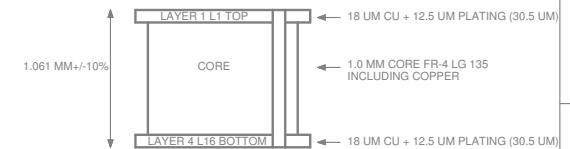
DRILL CHART: TOP TO BOTTOM

Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	17	YES
×	2	39	1.00	14	YES
□	3	40	1.02	12	YES

LAYER-STACK

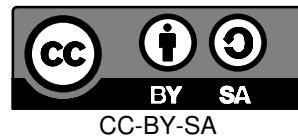


STACK-UP FOR REFERENCE



NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN MILLIMETERS EXCEPT TRACE WIDTH/SPACE
3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. BOARD TO HAVE WHITE SOLDER MASK ON PLATED SURFACES USING WET FILM SR100 OR SR1010 EPOXY.
EQUIVALENT WET OR DRY FILM MAY BE USED.
7. SILKSCREEN BOARD USING BLACK INK. DISTORTION OF SILKSCREEN IS ACCEPTABLE OVER TRACES. EPOXY INK ON PLATED LANDS IS NOT ACCEPTABLE
8. THE FOLLOWING INFORMATION APPLIES TO THIS BOARD:
 - * 2 COPPER LAYERS
 - * 1 MM BOARD THICKNESS
 - * REQUIRES TOP AND BOTTOM SIDE SILKSCREENS



Licensed under a Creative Commons Attribution-Share-Alike Unported License. See creativecommons.org/licenses/by-sa/4.0/

Reference designs are provided "AS IS" and "WITH ALL FAULTS". Michel Stempin disclaims all other warranties express or implied, regarding this product, including but not limited to, any implied warranties of merchantability or fitness for any particular application.

Michel Stempin may make changes to specifications and product description at any time, without notice.

© 2014, Michel Stempin.
All rights reserved.

Domino JTAG

23/07/14 09:57

Solder side (.SOL)

Rev. A